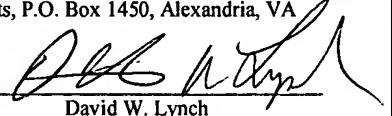


PATENT *TEW*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gill, et al Examiner: Watko, J.
Serial No.: 10/629,535 Group Art Unit: 2653
Filed: 07/29/03 Docket No.: HITG.054A
Title: Method and apparatus for enhancing thermal stability, improving biasing and
reducing damage from electrostatic discharge in self-pinned abutted junction
heads having a first self-pinned layer extending under the hard bias layer

CERTIFICATE UNDER 37 CFR 18: The undersigned hereby certifies that this correspondence and the papers, as described hereinabove, are being deposited in the United States Postal Service, as first class mail, in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on September 26, 2005.

By: 
David W. Lynch

REQUEST FOR CHANGE OF CORRESPONDENCE ADDRESS

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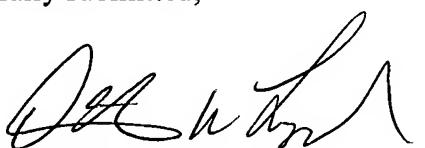
Dear Sir:

Please change the Correspondence Address for the above-identified application to:

Chambliss, Bahner & Stophel, P.C.
1000 Tallan Building
Two Union Square
Chattanooga, TN 37402
423-757-0264

Respectfully submitted,

Chambliss, Bahner & Stophel, P.C.
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By: 
Name: David W. Lynch
Reg. No.: 36,204